

Data sheet acquired from Harris Semiconductor SCHS066C- Revised October 2003

### CMOS 8-Bit Addressable Latch

High-Voltage Types (20-Volt Rating)

■ CD4099B 8-bit addressable latch is a serial-input, parallel-output storage register that can perform a variety of functions.

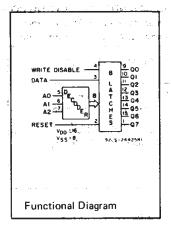
Data are inputted to a particular bit in the latch when that bit is addressed (by means of inputs A0, A1, A2) and when WRITE DISABLE is at a low level. When WRITE DISABLE is high, data entry is inhibited; however, all 8 outputs can be continuously read independent of WRITE DISABLE and address inputs.

A master RESET input is available, which resets all bits to a logic "0" level when RESET and WRITE DISABLE are at a high level. When RESET is at a high level, and WRITE DISABLE is at a low level, the latch acts as a 1-of-8 demultiplexer; the bit that is addressed has an active output which follows the data input; while all unaddressed bits are held to a logic "0" level.

The CD4099B types are supplied in 16-lead hermetic ceramic dual-in-line packages (F3A suffix), 16-lead plastic dual-in-line packages (E suffix), 16-lead small-outline packages (M, M96, MT, and NSR suffixes), and 16-lead thin shrink small-outline packages (PW and PWR suffixes).

#### Features:

- Serial data input Active parallel output
- Storage register capability Master clea
- Can function as demultiplexer
- Standardized, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μA at 18 V (full package-temperature range), 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range) = 1 V at V<sub>DD</sub> = 5 V, 2 V at V<sub>DD</sub> = 10 V, 2.5 V at V<sub>DD</sub> = 15 V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Séries CMOS Devices"



CD4099B Types

#### Applications:

- Multi-line decoders
- A/D converters

| MAXIMUM RATINGS, Absolute-Maximum Values:  | A BOOK STATE                         |
|--|--------------------------------------|
| DC SUPPLY-VOLTAGE RANGE, (VDD)   |                                      |
| Voltages referenced to VSS Terminal)   | 0.5V to +20V                         |
| INPUT VOLTAGE RANGE, ALL INPUTS  | 0.5V to V <sub>DD</sub> +0.5V        |
| DC INPUT CURRENT, ANY ONE INPUT  | ±10mA                                |
| POWER DISSIPATION PER PACKAGE (PD):  | And the second second second         |
| For T <sub>A</sub> = -55°C to +100°C   | 500mW                                |
|  |                                      |
| For T <sub>A</sub> = -55°C to +100°C   | Derate Linearity at 12mW/°C to 200mW |
| For TA = +100°C to +125°C  | Derate Linearity at 12mW/°C to 200mW |
|  |                                      |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR   | ackage Types) 100mW                  |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR TA = FULL PACKAGE-TEMPERATURE RANGE (AII P                                  | ackage Types)                        |
| DEVICE DISSIPATION PER OUTPUT TRANSISTOR FOR TA = FULL PACKAGE-TEMPERATURE RANGE (AII P OPERATING-TEMPERATURE RANGE (TA) | ackage Types)                        |

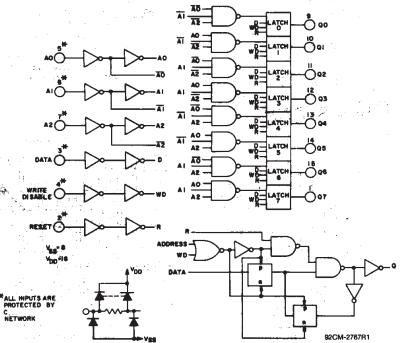
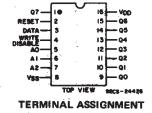


Fig. 1 — Logic diagram of CD4099B and detail of 1 of 8 latches.



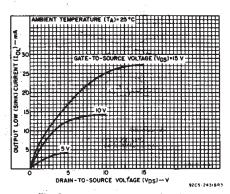


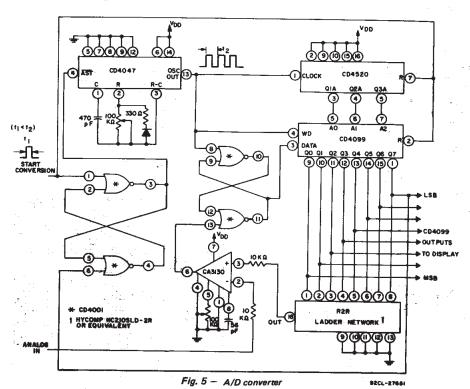
Fig. 2 — Typical output low (sink) current characteristics.

**RECOMMENDED OPERATING CONDITIONS** at  $T_A = 25^{\circ}$  C (Unless otherwise specified) For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

| CHARACTERISTIC   | SEE      | $v_{DD}$ | LIN  | UNITS    |      |
|--|----------|----------|------|----------|------|
|  | FIG. 15* | (V)      | MIN. | MAX.     | OWIS |
| Supply Voltage Range:<br>(At T <sub>A</sub> = Full Package<br>Temperature Range) |          |          | 3    | 18       | V.   |
| Minimum Pulse Width, tW  |          | 5        | 200  | -        |      |
| Data   | (4)      | 10       | 100  | _        |      |
|  |          | 15       | 80   |          | ٠.   |
|  |          | 5        | 400  | _        |      |
| Address  | (8)      | 10       | 200  |          | ns   |
|  |          | 15       | 125  | <u> </u> |      |
|  |          | 5        | 150  | . –      |      |
| Reset  | (5)      | 10       | 75   | _        | . ,  |
|  |          | 15       | 50   | -        |      |
| Setup Time, t <sub>S</sub>   |          | 5        | 100  | _        |      |
| Data to WRITE DISABLE  | (6)      | 10       | 50   | . –      |      |
|  |          | 15       | 35   | _        | ns   |
| Hold Time, tH  |          | 5        | 150  | _        |      |
| Data to WRITE DISABLE  |          | 10       | 75   | • –      | ns   |
|  |          | 15       | 50   | _        |      |

<sup>\*</sup> Circled numbers refer to times indicated on master timing diagram.

Note: In addition to the above characteristics, a WRITE DISABLE ON time (the time that WRITE DISABLE is at a high level) must be observed during an address change for the total time that the external address lines AO, A1, and A2 are settling to a stable level, to prevent a wrong cell from being addressed (see Fig. 3).



| MODE SELECTION |   |                                |  |  |  |  |  |  |  |  |  |
|----------------|---|--------------------------------|--|--|--|--|--|--|--|--|--|
| WD             | R | ADDRESSED<br>LATCH             | UNADDRESSED<br>LATCH                   |  |  |  |  |  |  |  |  |
| 0              | 0 | Follows Data                   | Holds Previous<br>State                |  |  |  |  |  |  |  |  |
| 0              | 1 | Follows Data<br>(Active High 8 | Reset to "0" -Channel Demulti- plexer) |  |  |  |  |  |  |  |  |
| 1              | 0 | Holds Previous State           |  |  |  |  |  |  |  |  |  |
| 1              | 1 | Reset to "0" Reset to "0"      |  |  |  |  |  |  |  |  |  |

WD = WRITE DISABLE

R = RESET

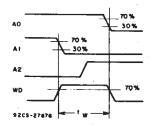


Fig. 3 - Definition of WRITE DISABLE ON time.

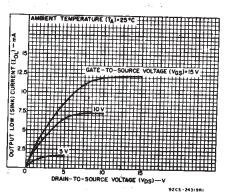


Fig. 4 — Minimum output low (sink) current characteristics.

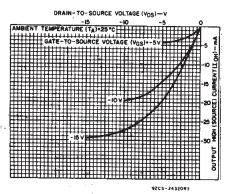
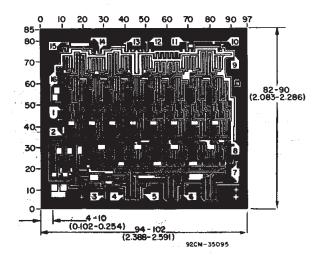


Fig. 6 - Typical output high (source) current characteristics.

#### STATIC ELECTRICAL CHARACTERISTICS

| CHARACTER-                | COND        | ıs         | LIMIT | LIMITS AT INDICATED TEMPERATURES (°C) |                |       |       |            |       | UNITS      |        |
|---------------------------|-------------|------------|-------|---------------------------------------|----------------|-------|-------|------------|-------|------------|--------|
| ISTIC                     | Vo.         | VO VIN VDD |       |                                       |                | .05   | .405  | +25        |       |            | Olaris |
|                           | (V)         | (V)        | (V)   | -55                                   | <del>-40</del> | +85   | +125  | Min.       | Тур.  | Max.       | :      |
| Quiescent Device          |             | 0,5        | 5     | 5                                     | 5              | 150   | 150   | <b>*</b> - | 0.04  | 5          |        |
| Current,                  | <u> </u>    | 0,10       | 10    | 10                                    | 10             | 300   | 300   | _          | 0.04  | 10         | μА     |
| IDD Max.                  |             | 0,15       | 15    | 20                                    | 20             | 600   | 600   |            | 0.04  | 20         | μ      |
|                           | -           | 0,20       | 20    | 100                                   | 100            | 3000  | 3000  | -          | 0.08  | 100        |        |
| Output Low                | 0.4         | 0,5        | 5     | 0.64                                  | 0.61           | 0.42  | 0.36  | 0.51       | 1     |            | _      |
| (Sink) Current            | 0.5         | 0,10       | 10    | 1.6                                   | 1.5            | 1.1   | 0.9   | 1.3        | 2.6   | <b>-</b> . |        |
| IOL Min.                  | 1.5         | 0,15       | 15    | 4.2                                   | 4              | 2.8   | 2.4   | 3 4        | 6.8   | _          |        |
| Output High               | 4.6         | 0,5        | 5     | -0.64                                 | -0.61          | -0.42 | -0.36 | -0.51      | -1    | -          | mA     |
| (Source)                  | 2.5         | 0,5        | 5     | -2                                    | -1.8           | -1.3  | -1.15 | -1.6       | -3.2  |            |        |
| Current,                  | 9.5         | 0,10       | 10    | -1.6                                  | -1.5           | -1.1  | -0.9  | -1.3       | -2.6  | _          |        |
| IOH Min.                  | 13.5        | 0,15       | 15    | -4.2                                  | 4              | -2.8  | -2.4  | -3.4       | -6.8  | -          |        |
| Output Voltage:           | 90 <u> </u> | 0,5        | 5     | 0.05                                  |                |       |       | -          | 0     | 0.05       |        |
| Low-Level,                | -           | 0,10       | 10    |                                       | 0              | .05   |       | -          | 0     | 0.05       |        |
| VOL Max.                  | _           | 0,15       | 15    |                                       | 0              | .05   |       | -          | 0     | 0.05       | v      |
| Output Voltage:           | -           | 0,5        | 5     |                                       | 4              | .95   |       | 4.95       | 5     | -          |        |
| High-Level,               | -           | 0,10       | 10    |                                       | 9              | .95   |       | 9.95       | 10.   | -"         |        |
| VOH Min.                  | -           | 0,15       | 15    |                                       | 14             | 1.95  |       | 14.95      | 15    | _          |        |
| Input Low                 | 0.5, 4.5    |            | 5     |                                       | 1              | 1.5   |       | _          | _     | 1.5        |        |
| Voltage,                  | 1, 9        | _          | 10    |                                       |                | 3     |       | _          | _     | 3          |        |
| VIL Max.                  | 1.5,13.5    | _          | 15    |                                       |                | 4     |       | _          | _     | 4          |        |
| Input High                | 0.5, 4.5    |            | 5     |                                       | 3              | 3.5   |       | 3.5        | _     |            | ٧      |
| Voltage,                  | 1, 9        | -          | 10    |                                       |                | 7     |       | 7          |       |            |        |
| VIH Min.                  | 1.5,13.5    | -          | 15    |                                       |                | 11    |       | 11         | _     | _          |        |
| Input Current<br>IIN Max. | _           | 0,18       | 18    | ±0.1                                  | ±0.1           | ,±1   | ±1    | -          | ±10-5 | ±0,1       | μА     |



# CD4099BH DIMENSIONS AND PAD LAYOUT

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10<sup>-3</sup> inch).

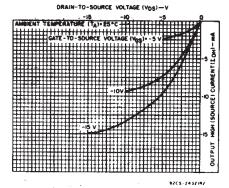


Fig.7 - Minimum output high (source) current characteristics.

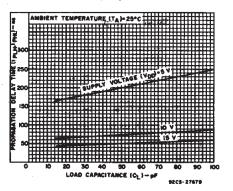


Fig. 8 — Typical propagation delay time (deta to Qn) vs. load capacitance.

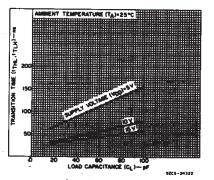


Fig. 9 — Typical transition time vs. load capacitance.

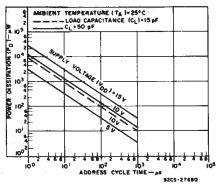


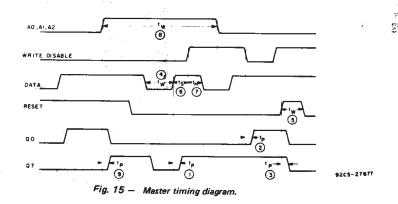
Fig. 10 — Typical dynamic power dissipation vs. address cycle time.

### CD4099B Types

# DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A$ = 25° C, $C_L$ = 50 pF, Input $t_F$ , $t_f$ = 20 ns, $R_L$ = 200 K $\Omega$

| CHARACTERISTIC                      | CONDI<br>SEE<br>FIG.15*                          | V <sub>DD</sub> | 1   | AITS (AGE TYPES | UNITS        |
|-------------------------------------|--|-----------------|-----|-----------------|--------------|
| Propagation Delay: tpLH,            |  | 5               | 200 | 400             |              |
| <sup>t</sup> PHL                    | 1  | 10              | 75  | 150             | ·            |
| Data to Output,                     |  | 15              | 50  | 100             |              |
| WRITE DISABLE                       | <del>                                     </del> | 5               | 200 | 400             |              |
| to Output, tpLH,                    | (2)  | 10              | 80  | 160             | ns           |
| t <sub>PHL</sub>                    |  | 15              | 60  | 120             |              |
|                                     |  | 5               | 175 | 350             |              |
| Reset to Output,                    | 3  | 10              | 80  | 160             |              |
| <sup>t</sup> PHL                    |  | 15              | 65  | 130             |              |
| Address to Output,                  |  | 5               | 225 | 450             |              |
| tPLH,                               | 9  | 10              | 100 | 200             |              |
| t <sub>PHL</sub>                    |  | 15              | 75  | 150             |              |
| Transition Time, t <sub>THL</sub> , |  | 5               | 100 | 200             | · .          |
| (Any Output) t <sub>TLH</sub>       |  | 10              | 50  | 100             | ns           |
|                                     |  | 15              | 40  | 80              |              |
| Minimum Pulse                       |  | 5               | 100 | 200             |              |
| Width, t <sub>W</sub>               | 4  | 10              | 50  | 100             | ns           |
| Data                                |  | 15              | 40  | . 80            |              |
|                                     |  | 5               | 200 | 400             | ··· <u>·</u> |
| Address                             | 8  | 10              | 100 | 200             | ns           |
|                                     |  | 15              | 65  | 125             |              |
|                                     |  | 5               | 75  | 150             |              |
| Reset                               | 5  | 10              | 40  | 75              | ns           |
|                                     |  | 15              | 25  | 50              |              |
| Minimum Setup                       |  | 5               | 50  | 100             |              |
| Time, tg                            | 6  | 10              | 25  | 50              | ns           |
| Data to WRITE DISABLE               |  | 15              | 20  | 35              |              |
| Minimum Hold                        |  | 5               | 75  | 150             |              |
| Time, t <sub>H</sub>                | 0 [  | 10              | 40  | 75              | ns           |
| Data to WRITE DISABLE               |  | 15              | 25  | 50              |              |
| Input Capacitance, CIN              | Any Inp  | out             | 5   | 7.5             | pF           |

<sup>\*</sup>Circled numbers refer to times indicated on master timing diagram.



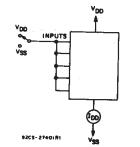


Fig. 11 — Quiescent device current test circuit.

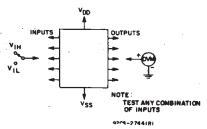


Fig. 12 - Input voltage test circuit.

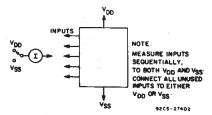


Fig. 13 - Input current test circuit.

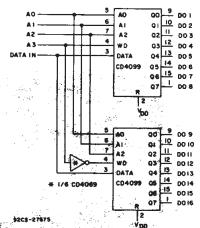


Fig. 14 - 1 of 16 decoder/demuttelexer.

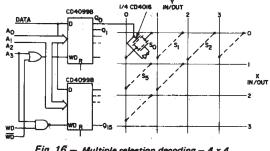


Fig. 16 — Multiple selection decoding — 4 x 4 crosspoint switch.





6-Feb-2020

#### **PACKAGING INFORMATION**

| Orderable Device | Status | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan                   | Lead/Ball Finish | MSL Peak Temp      | Op Temp (°C) | Device Marking<br>(4/5) | Samples |
|------------------|--------|--------------|--------------------|------|----------------|----------------------------|------------------|--------------------|--------------|-------------------------|---------|
| CD4099BE         | ACTIVE | PDIP         | N                  | 16   | 25             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | N / A for Pkg Type | -55 to 125   | CD4099BE                | Samples |
| CD4099BF         | ACTIVE | CDIP         | J                  | 16   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | CD4099BF                | Samples |
| CD4099BF3A       | ACTIVE | CDIP         | J                  | 16   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | CD4099BF3A              | Samples |
| CD4099BM         | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | CD4099BM                | Samples |
| CD4099BM96       | ACTIVE | SOIC         | D                  | 16   | 2500           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | CD4099BM                | Samples |
| CD4099BMG4       | ACTIVE | SOIC         | D                  | 16   | 40             | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | CD4099BM                | Samples |
| CD4099BNSR       | ACTIVE | so           | NS                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | CD4099B                 | Samples |
| CD4099BPWR       | ACTIVE | TSSOP        | PW                 | 16   | 2000           | Green (RoHS<br>& no Sb/Br) | NIPDAU           | Level-1-260C-UNLIM | -55 to 125   | CM099B                  | Samples |
| JM38510/17601BEA | ACTIVE | CDIP         | J                  | 16   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | JM38510/<br>17601BEA    | Samples |
| M38510/17601BEA  | ACTIVE | CDIP         | J                  | 16   | 1              | TBD                        | Call TI          | N / A for Pkg Type | -55 to 125   | JM38510/<br>17601BEA    | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.





6-Feb-2020

- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

#### OTHER QUALIFIED VERSIONS OF CD4099B, CD4099B-MIL:

Catalog: CD4099B

Military: CD4099B-MIL

NOTE: Qualified Version Definitions:

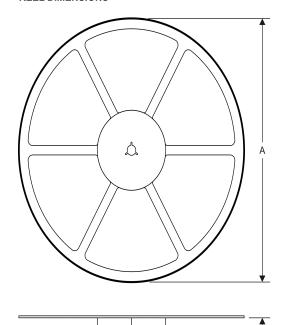
- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications

### PACKAGE MATERIALS INFORMATION

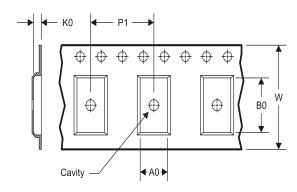
www.ti.com 14-Jul-2012

### TAPE AND REEL INFORMATION

### **REEL DIMENSIONS**







| A0 | Dimension designed to accommodate the component width     |
|----|---|
| В0 | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

### TAPE AND REEL INFORMATION

### \*All dimensions are nominal

| Device     | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| CD4099BM96 | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD4099BNSR | SO              | NS                 | 16 | 2000 | 330.0                    | 16.4                     | 8.2        | 10.5       | 2.5        | 12.0       | 16.0      | Q1               |
| CD4099BPWR | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |

**PACKAGE MATERIALS INFORMATION** 

www.ti.com 14-Jul-2012



\*All dimensions are nominal

| ń | 7 III GITTIOTOTOTO GEO TIOTITICA |                              |    |      |      |             |            |             |  |
|---|----------------------------------|------------------------------|----|------|------|-------------|------------|-------------|--|
|   | Device                           | Package Type Package Drawing |    | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |  |
|   | CD4099BM96                       | SOIC                         | D  | 16   | 2500 | 333.2       | 345.9      | 28.6        |  |
|   | CD4099BNSR                       | SO                           | NS | 16   | 2000 | 367.0       | 367.0      | 38.0        |  |
|   | CD4099BPWR                       | TSSOP                        | PW | 16   | 2000 | 367.0       | 367.0      | 35.0        |  |

### D (R-PDS0-G16)

### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# D (R-PDSO-G16)

### PLASTIC SMALL OUTLINE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.





SMALL OUTLINE PACKAGE



- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



### **MECHANICAL DATA**

### NS (R-PDSO-G\*\*)

## 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



### 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

### N (R-PDIP-T\*\*)

### PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



#### IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

Tl's products are provided subject to Tl's Terms of Sale (<a href="www.ti.com/legal/termsofsale.html">www.ti.com/legal/termsofsale.html</a>) or other applicable terms available either on ti.com or provided in conjunction with such Tl products. Tl's provision of these resources does not expand or otherwise alter Tl's applicable warranties or warranty disclaimers for Tl products.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265 Copyright © 2020, Texas Instruments Incorporated